



2065-30

Advanced Training Course on FPGA Design and VHDL for Hardware Simulation and Synthesis

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FPGA Applications in High Energy Physics

Alexander Kluge PH ESE FE Division CERN 385, rte Mayrin CH-1211 Geneva 23 Switzerland

FPGA applications in High Energy Physics

Alexander Kluge CERN



CERN – electronics system concepts a project cycle

Application: Data selection

Application: Data processing



Application overview CERN

CERN, experiments Aim General detector concept Examples



Principle of data acquisition & data flow



data selection: trigger data processing







Experiments



Principle of detectors









Principle of Data acquisition



Data selection



Principle of data acquisition



Data selection: trigger - FPGA

Front end: data taking-ASICs

Read out electronics-FPGA

Trigger processor

• Fast

- the faster, the less data needs to be pipelined/stored
- Compact
 - Many data channels are going into one processor system
- Connectivity
 - High number
 - Transmission delay on cables (5ns/m -> 200 m -> 1µs)

• Reliability

- Physics processes with a probability of 10⁻¹¹ need to recorded
- Processing and data transmission error rate >> 10⁻¹¹

- Quality control
 - Processes are verified in hardware and software processors
- Radioactive environment
- Data volume/rate
 - Many (100.000) parallel inputs in 25 ns intervall
- Parallel processing pipelined processing – FPGA
 - highly parallel because of many IOs and interconnectability

Example: Tracal Trigger

- Specifications
 - Calculate how many out of 1000 binary sensor inputs are active
 - Each 25 ns a new set of 1000 bits
 - Result required within 100 ns
- Solution possibilities
- Today and 10 years ago

System topology

- high number of inputs ->

 operation to simplify data and reduce data amount
- reduced number of inputs ->

 connected to more complex processing units
- at the end of processing chain ->
 - interest to integrate as much information into 1 FPGA to reduce interconnection



System topology: Interconnection:

- delay
 - (clock to pin, transmission outside FPGA, setup time)



System topology: Interconnection:

- Parallel interconnection:
 - high number of IOs, problem moved to board level
 - reliability impact due to solder joints or connectors



System topology: Interconnection:

- Serial interconnections at high speed
 - reduce reliability impact and increases delay (trigger needs to be fast)



System topology: Interconnection:

- delay
 - (clock to pin, transmission outside FPGA, setup time)
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- Serial interconnections at high speed
 - reduce reliability impact but increase delay (trigger needs to be fast)

 Interest to keep as much as possible within the same FPGA

Muon Track Finder Trigger Processor





- Size of detector system
 - -r = 14 m, length = 20 m
 - cable delay ~ 5 ns/m -> synchronisation
- Each 25 ns new data set
- 240 detector modules 200.000 detector cells
- Identify particles (muons)
- Measure curvature = momentum of particles within 400 ns
- Find 4 particles with highest momentum







200.000 sensors ->

240 chambers x 2 track segments = 480 track segments

1 track segment position (phi): 12 bits angle (phi_b): 10 bits quality code: 3 bits

25 bits * 480 track segment = 12000 bits 12000 bits * 40 MHz = 480 Gbit/s

How?
















Result of all extrapolation units is 180 bits -> data reduction Track assembly unit is combinatorial and looks for the longest possible track combination



Parameter assignment unit: momentum (5 bits) based on difference in position of layer 1 and 2





Extrapolation units: EP20k400EFC672 Data pipeline: 3 x EP1k100FC484 Track segment linker: EP20k300

16 layer PCB no pin level back annotation no board level simulation Soldering problems with ball grid





All in EP1S40F1020C7

8 layer PCB pin level back annotation board level VHDL simulation full JTAG boundary scan FPGA on daughter card



- Conclusion track finder:
- Data reduction
- Pipelining
- Feasibility study on possible algorithms
- Back annotation of Pins in FPGA after routing
- Full board multiple FPGA VHDL simulation
- Stimulus files from (costumer) simulation
- Planning at FPGA level has impact on system implementation

Example FPGA processors

Processor board with optical inputs







- System Specifications
- Different approaches possibilities
 - ASICs, CAM -> FPGA
 - Pattern recognition / Analytical approach => Mixture => successive data reduction
- Simulation Feasibility Forecast to future technologies
- Data flow simulation/calculation
 - buffer sizes
 - dead times

- Implementation scheme propose technology independent architecture
 - Do not push problems to a higher level IO pins, PCB, system
- Technology independent Simulation
 - Full system: system input patterns Qualification of data process
 - implement/integrate into system surrounding work on FPGA code
 - Simulation together with environment
 - other FPGAs
 - input data

- Implementation technology dependent
- Selection of components
 - Performance, features, evaluation, availability
 - price, age/phase in product cycle,
 - if very new -> support and access to high quantity difficult
 -> close connection to distributor
- Define strategy on Maintenance and upgrades
 - FPGA might get too full & slow after implementation of more and more functions
 - FPGA might get too old/obsolete during product cycle

- FPGA simulation/synthesis/place&route/backannotation
- Board Placing/routing
 - FPGA -> board -> FPGA
 - FPGA Back annotation/Board level of pin position-Feedback on board layout
- behavioral simulation of HDL code
 - back annotated gate level after routing with board/system level
 - SEU simulation

- Problems which are not solved on component level (ASIC/FPGA)
 - are pushed to the system level, become expensive and time consuming
- System level considerations ->
 - System level simulation
 - Multi designer environment
 - Multi component environment

Example design

- Prototype no internal design constraints on pin assignment for board layout -> 16 layer board ->
 - with assignment clean and 8 layer board

- Missing board level simulation with two FPGAs
 - simulation of each FPGA is OK together setup and hold time violations board delay
- Evolution of FPGA technology:
 - more than 1 FPGA with board routing ->
 - 1 FPGA no board routing

- Software/Hardware development must go hand in hand
- Debugging features in FPGAs/system/history/status
- Remote control is often required
 - how to implement
 - always one FPGA not reprogrammable as communication processor

- Board production
 - JTAG boundary scan is mandatory for BGA
 - Full system JTAG especially with multiple FPGAs on board
 - reduces turn around time
 - gives proof of problems to manufacturer
 - X-ray tests are not always conclusive (example not even copper on pads)
 - Soldering problems with prototype series
 - Test points

- Define strategy on Reliability
 - which date may be corrupted and which data must not be corrupted
 - radiation, SEU, cosmic rays on ground level
 - sub micron ASICs/FPGA